



## Material Content Data Sheet



<b>Sales Product Name</b>		IPA70R900P7S		<b>Issued</b>		1. August 2018		
<b>MA#</b>		MA001692912						
<b>Package</b>		PG-TO220-3-312		<b>Weight*</b>		2055.05 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	1.203	0.06	0.06	585	585
leadframe	inorganic material	phosphorus	7723-14-0	0.285	0.01		138	
	non noble metal	iron	7439-89-6	0.949	0.05		462	
wire	non noble metal	copper	7440-50-8	947.445	46.09	46.15	461034	461634
	non noble metal	aluminium	7429-90-5	0.248	0.01	0.01	121	121
encapsulation	organic material	carbon black	1333-86-4	11.252	0.55		5475	
	plastics	epoxy resin	-	175.200	8.53		85254	
leadfinish	inorganic material	silicondioxide	60676-86-0	906.258	44.10	53.18	440992	531721
	non noble metal	tin	7440-31-5	11.095	0.54	0.54	5399	5399
solder	non noble metal	antimony	7440-36-0	0.111	0.01		54	
	noble metal	silver	7440-22-4	0.278	0.01		135	
*deviation	non noble metal	tin	7440-31-5	0.722	0.04	0.06	351	540
					Sum in total:		100.00	

### Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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